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REMARKS

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Applicant respectfully submits that no new matter has been added by this amendment.

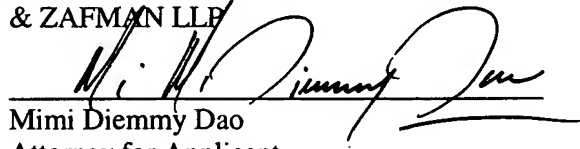
If the Examiner has any questions or comments, Applicant respectfully requests that the Examiner contact Mimi Dao at (408) 720-8300.

Deposit Account Authorization

Authorization is hereby given to charge our Deposit Account No. 02-2666 for any charges that may be due. Furthermore, if an extension is required, then Applicant hereby requests such extension.

Respectfully submitted,

BLAKELY, SOKOLOFF, TAYLOR
& ZAFMAN LLP


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Dated: January 17, 2002

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APPENDIX A

VERSION OF SPECIFICATION WITH MARKINGS:

[0047] The functional blocks 204 can be coupled to the receptor sites 203 by being flown over the backplane substrate 202 in a slurry solution (not shown). In general, these functional blocks 204 include semiconductors that are manufactured from silicon wafers (or other semiconducting materials). Alternatively, the functional blocks 204 can be a functional microstructure or a micro-scale electronic devices such as integrated circuit (not shown). These functional blocks 204 can also be the micro structure that have been invented and disclosed in a [copending U.S. Patent Application Serial Number 09/251,220 which was filed February 16, 1999 by the inventor John Stephen Smith] U.S. Patent No. 6,291,896, and which is entitled "Functionally Symmetric Integrated Circuit Die." This [application] patent is hereby incorporated herein by reference.